Wide Spectral Photoresponse of Layered Platinum Diselenide-Based Photodiodes

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ABSTRACT: Platinum diselenide (PtSe2) is a group-10 transition metal dichalcogenide (TMD) that has unique electronic properties, in particular a semimetal-to-semiconductor transition when going from bulk to monolayer form. We report on vertical hybrid Schottky barrier diodes (SBDs) of two-dimensional (2D) PtSe2 thin films on crystalline n-type silicon. The diodes have been fabricated by transferring large-scale layered PtSe2 films, synthesized by thermally assisted conversion of predeposited Pt films at back-end-of-the-line CMOS compatible temperatures, onto SiO2/Si substrates. The diodes exhibit obvious rectifying behavior with a photoresponse under illumination. Spectral response analysis reveals a maximum responsivity of 490 mA/W at photon energies above the Si bandgap and relatively weak responsivity, in the range of 0.1–1.5 mA/W, at photon energies below the Si bandgap. In particular, the photoresponsivity of PtSe2 in infrared allows PtSe2 to be utilized as an absorber of infrared light with tunable sensitivity. The results of our study indicate that PtSe2 is a promising option for the development of infrared absorbers and detectors for optoelectronics applications with low-temperature processing conditions.

KEYWORDS: Two-dimensional transition metal dichalcogenide, platinum diselenide, Schottky barrier diode, photodetector, spectral response, IR photodiode

Two-dimensional (2D) layered transition metal dichalcogenides (TMDs) are under investigation for use in future (opto)electronic device applications owing to their nanoscale thickness as well as their unique electrical and optical properties.1-3 To date, most studies on TMD-based electronic devices have focused on group-6 TMDs such as molybdenum/tungsten (Mo/W) disulfide/diselenide (S2/Se2).3-9 Various scalable and controllable growth techniques for such materials have been developed, mostly based on chemical vapor deposition (CVD) or vapor phase deposition.10-16 and the opportunity for manufacturable device applications has become much broader, leading to increased research on transistors, sensors, and optoelectronic devices.9,17-21

In contrast to group-6 TMDs, group-10 TMDs, such as platinum/palladium (Pt/Pd) disulfide/diselenide (S2/Se2), have thus far been little explored. Even though theoretical studies on the electronic properties of group-10 TMDs started in the 1960s,22-24 experimental studies on their use for electronic device applications have only been introduced very recently.25-28 In particular, PtSe2 has drawn attention due to its unique electronic property whereby theoretical studies proposed a transition from semimetal to semiconductor as the layer number decreases.24,29,30 Wang et al. were able to grow PtSe2 by direct selenization of Pt single crystals under ultrahigh vacuum conditions and experimentally demonstrated that monolayer PtSe2 is semiconducting with an indirect
bandgap of 1.2 eV, unlike semimetallic bulk PtSe2 with zero bandgap.31 Furthermore, with recent developments in the synthesis of layered PtSe2 thin films in a scalable and controllable way, it has been utilized in various nanoelectronic devices, including gas sensors, photodetectors, and photovoltaic cells, showing notable performance.25,30 Due to this thickness-dependent transition, a wide range of device applications, especially in optoelectronics, can be envisioned for PtSe2. In particular, the thickness dependence of the bandgap in PtSe2 suggests the possibility of infrared (IR) photodetection. Despite the fact that various 2D TMDs have been employed in photodetectors,32 IR detection has rarely been achieved as most TMDs are semiconducting with an appreciable bandgap. Vertically illuminated Schottky photodetectors can be fabricated by forming simple metal–semiconductor contacts. They are advantageous for high-speed applications due to their majority-carrier-dominant current-flow mechanism, and Schottky photodetectors based on III–V materials (e.g., GaAs, InGaAs, InAlAs, etc.) have also been utilized for near-IR/IR detection.33,34 However, the high reflectance of conventional metal Schottky contact layers deteriorates the device performance, resulting in low efficiency. Though transparent conductors, such as indium tin oxide (ITO), were introduced to overcome this drawback,35,36 it is necessary to use additional layers for antireflectance and enhancement of light absorption. Compared to transparent-conductor-based IR photodetectors, 2D-material-based photodetectors can be thinned down relatively easily by reducing the thickness of the 2D top contact layers to a few nanometers as the 2D layer acts as a conductive electrode as well as a light absorber. In addition, it is possible to tune the optical properties of the 2D layers by controlling the layer thickness, enabling a broad range of wavelength detection. The mechanical flexibility of layered materials also strengthens the case for their future use in flexible device applications. Graphene has been studied as an active layer for graphene-Si Schottky photodiodes.37,38 Its gapless semimetallic nature allows graphene to be utilized as an IR detector; however, the limited light absorption of graphene, owing to its monolayer structure, and relatively complex processes associated with stacking multilayers hinder broader applications of graphene-based IR detection. On the contrary, multilayer PtSe2, with a small (<0.2 eV) or zero bandgap,31 can be expected to absorb light over a very wide energy spectrum and generate photon-induced charge carriers, thus enabling broadband photodetection.

In this work, we investigate the wide spectral photoresponse of PtSe2-based electronic devices. In our previous study, we demonstrated PtSe2-based photodiodes and examined their general photoconductivity and photovoltaic effects under white light illumination.25 The layered PtSe2 thin films were fabricated in a similar manner with various thicknesses synthesized by thermally assisted conversion (TAC) of predeposited Pt layers. Schottky barrier diodes (SBDs) were fabricated by transferring layered PtSe2 thin films onto n-type Si (n-Si). Here, in addition to the basic investigation of the electrical characteristics of the hybrid PtSe2/n-Si SBDs by dc current–voltage measurements in ref25, the photoresponse of the SBDs was comprehensively examined over a wavelength range of 360–2000 nm (0.62–3.44 eV). It was found that there is a notable difference in responsivity depending on the photon energy range. A responsivity of 490 mA/W and a relatively weak responsivity of 0.1–1.5 mA/W were obtained at photon energies above and below the Si bandgap, respectively. In particular, our current study enables deeper understanding and quantification of the photoresponse of the PtSe2-based photodetectors by offering insight into their spectral response and photoconductivity. The results show that PtSe2 is a
promising candidate for the development of infrared absorbers and detectors.

A schematic of the furnace for the TAC process is shown in Figure 1a. The thicknesses of the PtSe₂ films were controlled by depositing initial Pt layers with different thicknesses. A photograph of PtSe₂ films with 1, 2, 3, and 5 nm of starting Pt grown on quartz substrates is shown in Figure 1b. It has been revealed that the initial Pt thickness expands approximately four times after selenization. As the single layer PtSe₂ thickness is ~0.7 nm, the number of layers for the PtSe₂ films selenized from 1, 2, 3, and 5 nm thick initial Pt layers can be estimated as approximately 6, 11, 17, and 29 layers, respectively. It should be stressed that a relatively low growth temperature (of 400 °C) is used in this process. This is an advantage over other TMD growth conditions based on chemical vapor deposition (CVD) or vapor phase deposition, wherein higher process temperatures (>600 °C) are necessary for large-scale growth. This suggests that generally PtSe₂ can be used in standard back-end-of-line (BEOL) processing of classic semiconductor technology for cointegration of electronic, optoelectronic, or nanoelectromechanical system (NEMS) applications.

A cross-sectional transmission electron microscopy (TEM) image of the PtSe₂ synthesized from the 1 nm thick Pt initial layer (Figure 1c) shows a clear multilayered structure with 5–6 layers of PtSe₂ (~3.5 nm thick). This shows that the initial metal layer is converted entirely to layered PtSe₂ by the TAC process. It also can be seen that the layers are well aligned parallel to the substrate, even though it is known that TAC-grown PtSe₂ film yields polycrystalline. Raman spectra of PtSe₂ films on SiO₂/Si substrates with different thicknesses, synthesized from initial Pt thicknesses of 1, 2, 4, and 5 nm, are depicted in Figure 1d. Two dominant peaks are observed at ~177 and ~206 cm⁻¹, which represent the E₇ and A₁g Raman active modes of layered PtSe₂ with a 1T-type crystal structure, respectively. The E₇ mode is related to an in-plane vibration of Se atoms, and the A₁g mode reflects an out-of-plane vibration of Se atoms. A higher relative A₁g peak intensity, in combination with a slight red shift of the E₇ peaks, is observed as the film gets thicker. As presented in a previous report, the rise in intensity of the A₁g mode can be attributed to an increased out-of-plane contribution, which may stem from increased van der Waals interactions in the thicker films.

As-grown PtSe₂ films with various thicknesses were transferred onto prepatterned n-Si substrates using a polymer-supported transfer method, resulting in PtSe₂/n-Si SBDs. A schematic diagram and photograph of the fabricated device are shown in Figure 2a, and details of the fabrication process are described in the Methods section. Initially, electrical measurements of the devices were carried out in dark conditions. Figure 2b depicts the dc current density–voltage (J–V) plots of the device with a PtSe₂ film grown from a 1 nm thick Pt layer. In dark conditions, clear rectifying behavior was observed, indicating that the device acts as a SBD. The current–voltage characteristics of SBDs follow thermionic emission theory and

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charge carriers can be generated in the PtSe2 layer, in the energy band diagram of the PtSe2/n-Si Schottky junction under reverse bias in the dark, it shows a notable increase of the reverse bias can be derived (Figure 2d). The photon-induced charge carriers can be generated in the PtSe2 layer, in the depletion layer, and the silicon, depending on the incident photon energy and the absorption coefficients. When the incident photon energy (hν) is \( \varphi_h < h\nu < E_g \) where \( E_g \) is the bandgap of Si (\( \sim 1.1 \) eV), only electrons excited in the PtSe2 can contribute to the photocurrent. In the case of \( E_g \leq h\nu \), electron–hole pairs generated at the depletion region of the PtSe2–Si junction as well as the Si region can also contribute to the photocurrent. Similar white-light photocconductivity effects were observed for other PtSe2/n-Si SBDs with different PtSe2 film thicknesses. The \( J–V \) plots of diodes with PtSe2 derived from 2, 4, and 5 nm thick Pt layers are presented in Figure S2 of the Supporting Information.

Spectral response (SR) measurements of the PtSe2/n-Si SBDs were carried out in order to examine how photons of different wavelength (energy) contribute to the generation of photocurrent. The absolute SR of the PtSe2/n-Si SBDs was measured over a broad wavelength range (360–2000 nm, 0.62–3.44 eV) under zero and reverse dc biases. The SR data of the SBDs with PtSe2 films grown from 1 and 4 nm starting Pt are plotted in Figure 3a,b, respectively. Higher responsivity is observed at a higher reverse bias for both devices. They exhibit very similar behavior showing maximum SR peaks at \( \sim 970 \) nm (\( \sim 1.28 \) eV), which is the fingerprint of absorption in the bottom n-Si sublayer. Very low responsivity is observed at energies below the Si bandgap (\( E_g < \sim 1.1 \) eV), implying that PtSe2 solely contributes to the SR in this region. Additional SR data of the SBDs with PtSe2 films from 2 and 5 nm starting Pt are presented in Figure S4 of the Supporting Information. The SR of the SBDs with different PtSe2 thicknesses under dc bias of –2 V are compared in Figure 3c and zoomed in on the IR response in Figure 3d. All devices are responsive from the ultraviolet (UV) to the near-infrared (NIR) region. The SBD with a PtSe2 layer from 1 nm starting Pt shows a high maximum responsivity of \( \sim 490 \) mA/W, while the three devices with thicker PtSe2 show lower maximum responsivities of 250–270 mA/W. These values are in the range of the responsivity of recently reported graphene/Si heterojunction photodetectors (270–730 mA/W).
MoS2-based photodetectors (10−210 mA/W). However, the responsivity begins to drop dramatically in the IR region due to the exclusion of the Si contribution to the photocurrent, showing a responsivity range of 0.1−1.5 mA/W with a clear PtSe2 thickness dependence. This is consistent with previous graphene/Si photodetectors, which give a responsivity of less than 0.2 mA/W in the IR region. Such a weak responsivity in the IR region can be explained by the internal photoemission effect (IPE), whereby electrical carriers generated in the (semi)metallic layer by photon absorption overcome the Schottky barrier and contribute to the photocurrent. Unlike typical IPE-based Schottky photodetectors, the PtSe2/n-Si SBDs do not show any noticeable drop in responsivity at the energy of their Schottky barrier height (0.7 eV, 1770 nm). The additional photocurrent energies below the Schottky barrier height could be caused by the contribution of defect-induced traps at the interface, considering the PtSe2 film transfer processes wherein wet-etching processes of SiO2 layers are included. Furthermore, the additional photocurrent could stem from the contribution of randomly distributed semiconducting few-layered PtSe2 patches. As previously reported, TAC-grown PtSe2 has a polycrystalline structure with randomly distributed grains, consisting of multilayer PtSe2 with several different layer numbers. Similar structures have also been observed for TAC-grown MoS2. The incident photons with lower energies than the Schottky barrier height can induce electron–hole pairs at the partially distributed semiconducting few-layered PtSe2 crystallites with small bandgap (<0.3 eV), contributing additional photocurrent. Silicon Schottky photodiodes based on IPE have been frequently used for IR detection owing to their simple structure and ease of fabrication. IR responsivity of the PtSe2-based Schottky diodes is comparable to the responsivity of conventional IPE-based Schottky photodetectors with thin metal (e.g., Cu and Al) layers, which showed a room-temperature responsivity of 0.1−5.5 mA/W at the wavelength of 1550 nm. However, compared to IPE-based Schottky photodetectors using metal silicide layers such as Pd3Si and PtSi, which have a maximum responsivity of 50−60 mA/W at 1550 nm at low operating temperatures (40−140 K), the PtSe2-based Schottky diodes show inferior performance. Nevertheless, it is expected that the device performance of the PtSe2 photodetectors can be improved by further optimization of fabrication processes. Moreover, the 2D layered feature of PtSe2 is still beneficial for future applications, such as the formation of very thin 2D heterostructures by stacking the layered PtSe2 with other semiconducting 2D layered TMDS like MoS2 and WSe2. The thickness dependence of the responsivity of the PtSe2/n-Si SBDs can be understood by examining the light absorbance of the PtSe2 films: In the energy range above 1.1 eV, thinner films absorb less of the incident light than the thicker films, allowing more photons to reach the Si substrate and resulting in a higher responsivity. However, in the IR region where there is no Si contribution to the responsivity, devices with thicker PtSe2 layers show higher responsivity. This can be attributed to the larger volume for photon absorption in thicker PtSe2 films, allowing more photon-induced charge carriers from PtSe2 to contribute to the photocurrent. This is well supported by the transmittance and absorbance data of PtSe2 films in Figure 4a,b (initial Pt thicknesses of 1, 2, 3, and 5 nm, respectively), which was obtained on quartz substrates in the visible to IR wavelength region (400−2000 nm). As expected, thicker films show lower transmittance and higher absorbance than thinner films over the entire wavelength range. In particular, the thinnest PtSe2 film (1 nm starting Pt) shows an absorbance of 2 to 15% in the IR region, which is in the same range of graphene (~2.3%). Considering the potential superior manufacturability of PtSe2 due to its low growth temperature and the ease of film-thickness modulation, one can strongly suggest that PtSe2 offers significant advantages over graphene in optoelectronics and has great potential for applications in the IR region.

In summary, we have realized vertical hybrid PtSe2-based diodes and examined their optoelectronic properties. The layered PtSe2 thin films were synthesized at low temperature, with controlled thickness in a scalable and manufacturable manner via TAC of predeposited Pt. The PtSe2 films form a Schottky barrier diode when transferred onto prepatterned n-Si substrates. The SBDs demonstrate a clear photoresponse under illumination and have a comparable responsivity to other 2D-material-based photodiodes. Spectral response measurements reveal that a large part of the photocurrent in the visible wavelength range is generated in the Si sublayer of the diode. However, in the IR region, PtSe2 acts as a strong absorber with clear thickness dependence. Compared to other IR absorbers based on 2D materials, like graphene or black phosphorus, PtSe2 is highly advantageous because it can potentially be integrated with standard semiconductor processing due to its low growth temperature. In addition, the absorbance of such devices can be tuned through film thickness modulation. Therefore, this work strongly suggests PtSe2 as a promising 2D material for future IR optoelectronics.

Methods. Layered PtSe2 thin films were synthesized using a TAC process, as detailed in previous work. In short, Pt films of various thicknesses were sputter deposited onto SiO2/Si substrates using a Gatan precision etching and coating

![Image](https://example.com/image.png)
system. These films were converted to PtSe2 in a two-zone furnace with the Pt films heated to 400 °C in zone one of the furnace and Se pellets heated to 220 °C in zone two of the furnace, which was upstream from zone one.

An n-type Si (n-Si) wafer (phosphorus, 5 × 10^{14} cm^{-3}, (100)) with a thermally grown SiO2 (150 nm thick) layer on top was used to prepare substrates for the devices. A defined area of the SiO2 layer was removed by a hydrofluoric acid (HF, 3% diluted) wet etching process. After rinsing with deionized (DI) water, metal electrodes (titanium/gold (Ti/Au), 20/50 nm) were sputtered on the exposed n-Si and the remaining SiO2 region using a shadow mask. After removing the native oxide layer from the n-Si surface using a HF wet-etching process, as-grown PtSe2 thin films were transferred onto the prepatterned n-Si substrates by using a polymer-supported transfer method with poly(methyl methacrylate) (PMMA, MicroChem). The transferred PtSe2 films are in direct electrical contact with the underlying n-Si, realizing SBDs with an active area of ∼25 mm2. A schematic diagram and photograph of such a device are shown in Figure 2a.

TEM analysis was performed in a JEOL JEM-2100 operating at 200 kV in bright field mode. The lamella was prepared by depositing 50 nm carbon, 300 nm platinum, and 2 μm carbon protective layer stacks within a dual beam focused ion beam (FIB) FEI Helios NanoLab 600i. The lamella was then thinned down to less than 200 nm thickness.

Raman spectra of the PtSe2 samples were measured using a Witec Alpha 300 R confocal Raman microscope. The spectra were acquired with an excitation wavelength of 532 nm and a scanning grating of 1800 lines/mm.

Hall effect measurements were performed in a van der Pauw configuration with a LakeShore Model 8404 AC/DC Hall Effect Measurement System. The system can provide dc or ac magnetic fields over a variable range up to ±1.7 T (dc) or a fixed range up to ±1.2 T RMS at a frequency of 0.1 Hz (or 0.05 Hz).

Electrical characterization of the diodes was conducted under ambient conditions using a Karl Süss probe station connected to a Keithley 2612A source meter unit. The PtSe2 region of the diode was positively biased, and the n-Si was negatively biased. The photocurrent of the device was tested by using a white light source with a solid state dimmer for variable light intensity (ACE Light Source, SCHOTT A20500, 150 W halogen lamp).

The spectral response (SR) of the SBDs was measured using a lock-in technique by comparing them to calibrated reference detectors. A monochromator was used to select a particular wavelength of the tungsten-halogen lamp light source. The light power density varied from 1 μW cm^{-2} at a wavelength of 200 nm up to 55 μW cm^{-2} at a wavelength of 1150 nm. The intensity of the light beam was modulated by a chopper with a frequency of 17 Hz. Calibrated Si and indium gallium arsenide (InGaAs) diodes were used for calibration of the setup and also as reference detectors. The photocurrent was measured by preamplifiers and lock-in amplifiers at the working frequency of the chopper for detection of ultralow current values down to 10 pA. A schematic diagram of the SR measurement system is shown in Figure S3 of the Supporting Information.

Transmittance/absorbance data of the PtSe2 films on quartz substrates were measured using a custom-built optical setup. Chopped monochromatic light of a stabilized tungsten-halogen light source and lock-in (EG&G Model 5210) amplification technique were used to suppress noise and enhance the detection of ultralow current with high accuracy. The optical properties of the films were characterized by using calibrated germanium photodiodes (SN1792), from the visible to the IR range (3.1–0.6 eV, 400–2000 nm) with a step size of 0.2 eV.

**ASSOCIATED CONTENT**

# Supporting Information

The Supporting Information is available free of charge on the ACS Publications website at DOI: 10.1021/acs.nanolett.7b05000.

Details of Hall effect measurements, additional photoresponse data of the PtSe2/n-Si SBDs with various PtSe2 film thicknesses, schematic diagram of the SR measurement system, and additional SR plots of the PtSe2/n-Si SBDs with various PtSe2 film thicknesses (PDF)

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**Notes**

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